

Electronic Patent Application Fee Transmittal				
Application Number:		10598469		
Filing Date:		17-May-2007		
Title of Invention:		Multilayer Substrate Manufacturing Method		
First Named Inventor/Applicant Name:		Takeshi Nakamura		
Filer:		Jan Felix Grasbon/Melvin Smith		
Attorney Docket Number:		14225-112US1 F1040898US00		
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
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Extension - 1 month with \$0 paid	1251	1	130	130

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Total in USD (\$)				130